

<u>GENERAL</u>

EPORITE 2090 is a one-component thermal conductive adhesive recommended especially for adhesion on various electronic parts required thermal conductive property. The cured EPORITE 2090 exhibits excellent physical and dielectric properties, and heat stability.

<u>STORAGE</u>

Seal the containers tightly & store at temperature lower than 5°C but not less than -10°C. Unfreeze at room temperature at least 2 ~ 4 hour before using.

<u>HANDLING AND</u> <u>SAFETY</u>

Gloves and glasses are suggested for user's personal protection. Clean with soap and water when skin contact.

PROCESSING

- Unfreeze at room temperature at least 2 ~ 4 hour before using.
- 2. Apply EPORITE 2090 on the adhesion surface.
- 3. Attach two parts and cure at temperature 130 $^{\circ}C/2$ hr. or 150 $^{\circ}C/1$ hr.

SPECIFICATION

Specification	EPORITE 2090
Chemical Type	Epoxy Compound
Appearance	Black Paste
Specific Gravity	$1.5 \pm 0.1 \text{ g/cm}^3$
Viscosity(25°C)	$25000 \pm 5000 \text{ cps}$
Shelf Life (5°C)	3 months
Gel Time(130°C)	40 min/ 0.2g (thin coating)
Curing Condition	130°C/2 hr or 150°C/1 hr

PROPERTIES OF THE CURED RESIN

Property	EPORITE 2090
Hardness (Shore D)	85 ~ 95
Glass Transition Temperature (°C)	120 ~ 140
Coefficient of Thermal Expansion (mm/mm/°C)	$(\alpha_1) 50 \sim 70 \times 10^{-6}$ $(\alpha_2) 120 \sim 180 \times 10^{-6}$
Moisture Contain (wt%)	< 0.3
Adhesive Strength (kg/cm ²)	> 85

REMARK

The information contained is believed to be reliable and only for the reference without any effective guarantee for the application of the user. The user is responsible to determine the suitability for the user's application and the reliability of the products. Epolab Chemical will not accept claim of warranties of the fitness or reliability for a particular purpose especially the liability for consequential damages of end products.



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